

Preparation of multi-channel readout for a GaAs pad sensor

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H. Henschel DESY (Zeuthen)

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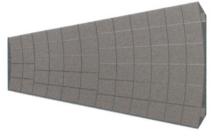
Sensors

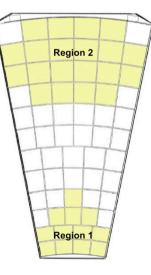
 provided by RID Tomsk through JINR Dubna version 2011, 22.5° - 12 rings, 64 pads

Sensor chosen: AG 221 No 25

selected from comparison of

- leakage current in selected areas
- pad capacitances
- guard ring behaviour









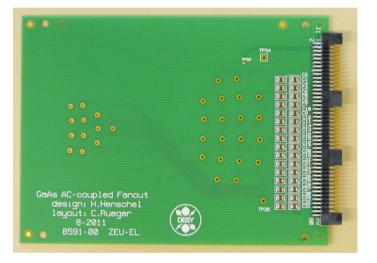


Fanout

• version 2011

0.5mm thick pcb pluggable to RO board reading out 32 channels in two areas implementing AC coupling

designed, manufactured and assembled



- Sensor to be bonded and tested (C- & crosstalk measurements)

- Shielding?

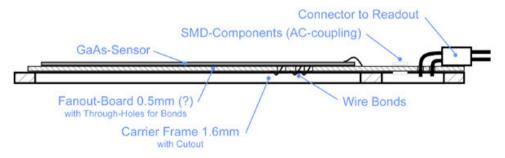




Carrier Frame

- required to support sensor and Fanout
- to be desgend & manufactured







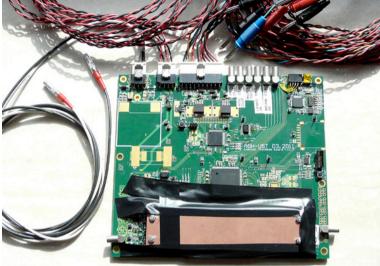
Testbeam 2011



Frontend Electronics

RO board, provided by Krakow

- 32-channel readout (8 channels analog) HV feed on-board sampling ADC
- FPGA for data processing/pipelining μ -processor for board operation/slow control
- delivered
- cables manufactured
- software installed
- to be operated & understood!
- to be tested with testpulses & readout
- sensor to be added & tested









Operation

FPGA configurator

software & download cable r.t.u.

µ-processor access & operation environment

software installed? access cable exists

Know how & source code?

software installed (Olga)

• Readout

requirements to be checked (software, USB or dedicated cable)